



No.4745

2SJ258

P-Channel MOS Silicon FET

Very High-Speed
Switching Applications**Features**

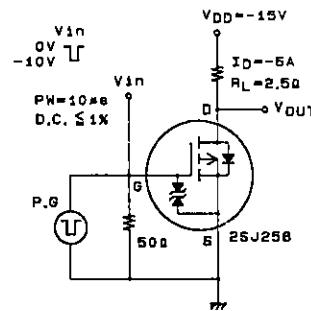
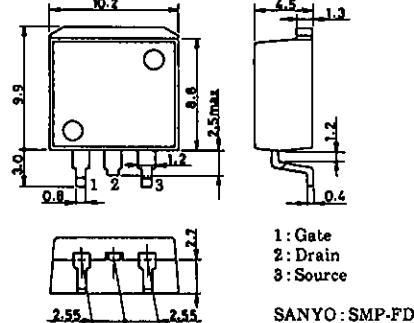
- Low ON resistance.
- Very high-speed switching.
- Low-voltage drive.
- Surface mount type device making the following possible
 - Reduction in the assembling time for 2SJ258-applied equipment
 - High-density surface mount applications
 - Small size of 2SJ258-applied equipment

Absolute Maximum Ratings at Ta = 25°C

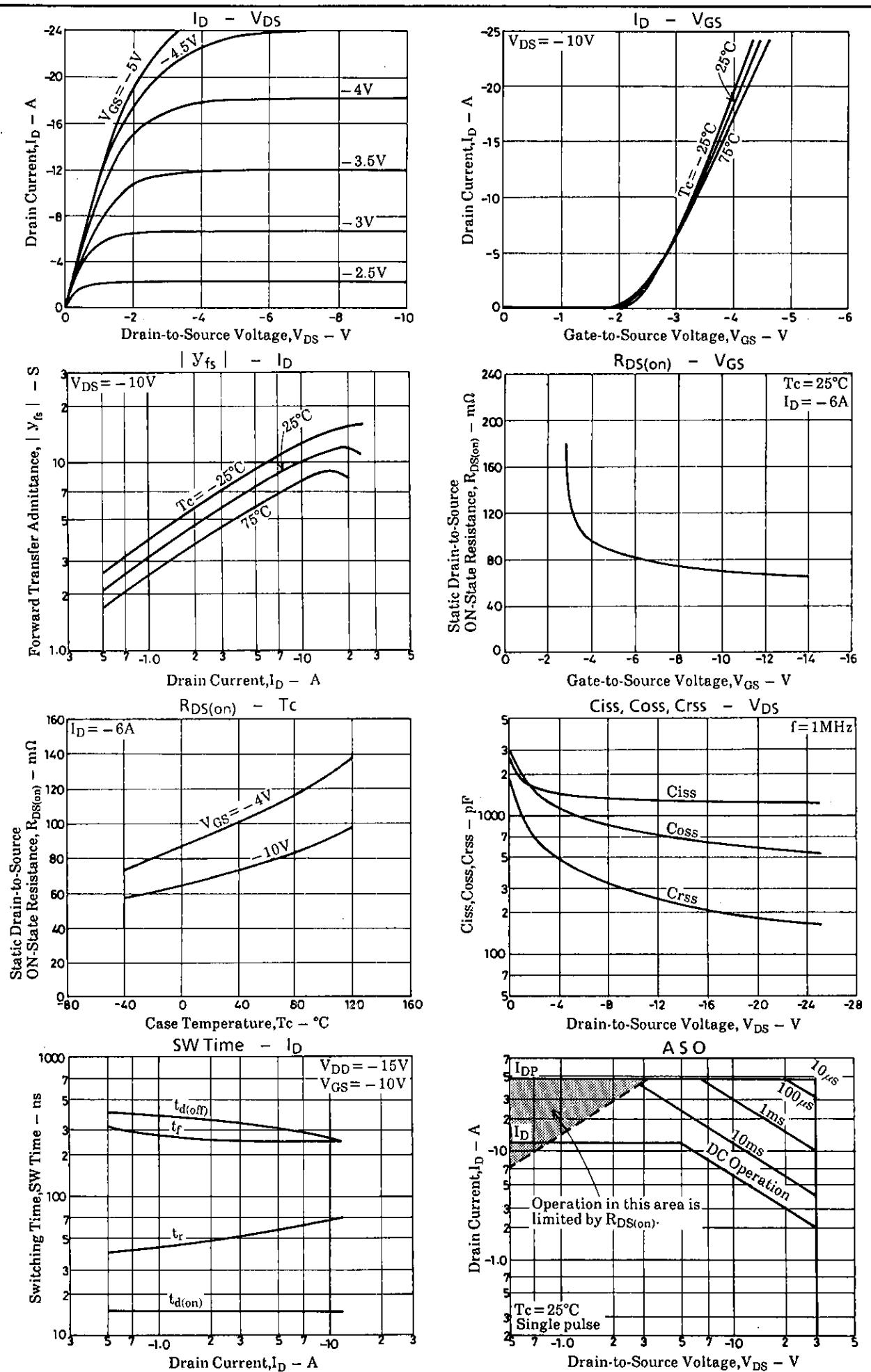
			unit
Drain-to-Source Voltage	V _{DSS}	-30	V
Gate-to-Source Voltage	V _{GSS}	±20	V
Drain Current(DC)	I _D	-12	A
Drain Current(Pulse)	I _{DP}	PW ≤ 10μs, duty cycle ≤ 1% -48	A
Allowable Power Dissipation	P _D	1.65	W
		60	W
Channel Temperature	T _{ch}	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

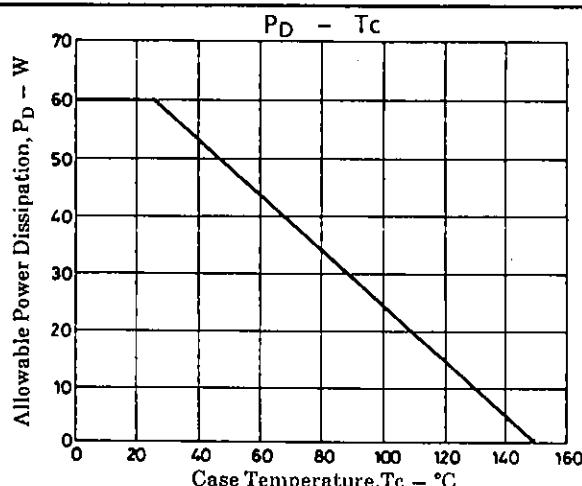
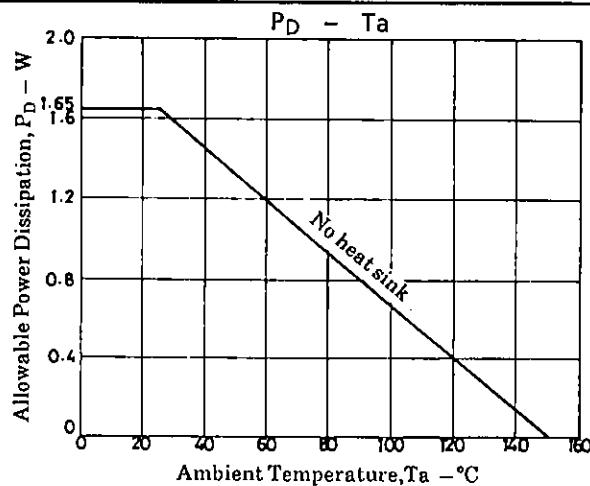
Electrical Characteristics at Ta = 25°C

			min	typ	max	unit
D-S Breakdown Voltage	V _{(BR)DSS}	I _D = -1mA, V _{GS} = 0	-30			V
G-S Breakdown Voltage	V _{(BR)GSS}	I _G = ±100μA, V _{DS} = 0	±20			V
Zero-Gate Voltage	I _{DSS}	V _{DS} = -30V, V _{GS} = 0			-100	μA
Drain Current						
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = ±16V, V _{DS} = 0			±10	μA
Cutoff Voltage	V _{GS(off)}	V _{DS} = -10V, I _D = -1mA	-1.0		-2.0	V
Forward Transfer Admittance	Y _{fs}	V _{DS} = -10V, I _D = -6A	5	8		S
Static Drain-to-Source	R _{DS(on)}	I _D = -6A, V _{GS} = -10V		0.07	0.095	Ω
ON-State Resistance	R _{DS(on)}	I _D = -6A, V _{GS} = -4V		0.095	0.13	Ω
Input Capacitance	C _{iss}	V _{DS} = -10V, f = 1MHz		1300		pF
Output Capacitance	C _{oss}	V _{DS} = -10V, f = 1MHz		780		pF
Reverse Transfer Capacitance	C _{rss}	V _{DS} = -10V, f = 1MHz		290		pF
Turn-ON Delay Time	t _{d(on)}	See specified Test Circuit.		16		ns
Rise Time	t _r	"		60		ns
Turn-OFF Delay Time	t _{d(off)}	"		300		ns
Fall Time	t _f	"		250		ns
Diode Forward Voltage	V _{SD}	I _S = -12A, V _{GS} = 0	-1.0	-1.5		V

Switching Time Test Circuit**Package Dimensions 2090A**
(unit : mm)

SANYO Electric Co., Ltd. Semiconductor Business Headquarters
TOKYO OFFICE Tokyo Bldg., 1-10, 1 Chome, Ueno, Taito-ku, TOKYO, 110 JAPAN





- No products described or contained herein are intended for use in surgical implants, life-support systems, aerospace equipment, nuclear power control systems, vehicles, disaster/crime-prevention equipment and the like, the failure of which may directly or indirectly cause injury, death or property loss.
- Anyone purchasing any products described or contained herein for an above-mentioned use shall:
 - ① Accept full responsibility and indemnify and defend SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors and all their officers and employees, jointly and severally, against any and all claims and litigation and all damages, cost and expenses associated with such use;
 - ② Not impose any responsibility for any fault or negligence which may be cited in any such claim or litigation on SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors or any of their officers and employees jointly or severally.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. SANYO believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.